Docket No. 14945

Declaration and Power of Attorney For Patent Application English Language Declaration

As a below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name,

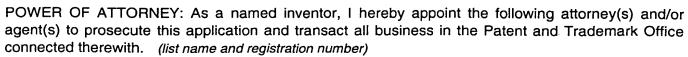
I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled

SEMICONDUCTOR APPARATUS FOR PROVIDING RELIABLE DATA ANALYSYS OF SIGNALS

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디 Uthe	specification of whi	ch į							
្វា ប្រា(ch	eck one)								
	is attached hereto.								
	was filed on	_		as United	States Application No	. or PCT International			
a Cj	Application Number	r							
4.	and was amended on								
	(if applicable)								
A h	hereby state that I have reviewed and understand the contents of the above identified specification, including the claims, as amended by any amendment referred to above.								
kno Sec I h Sec any listo	own to me to be motion 1.56. ereby claim foreign ction 365(b) of any PCT International and below and have a	prio foreigapplicalso i PCT	al to patentabili rity benefits un gn application(s cation which des dentified below,	ty as define der Title 35) for patent signated at le by checking	d in Title 37, Code of United States Code, or inventor's certificate east one country other the box, any foreign a	k Office all information f Federal Regulations, Section 119(a)-(d) or e, or Section 365(a) of than the United States, application for patent or e that of the application			
Pri	or Foreign Application	on(s)				Priority Not Claimed			
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I hereby claim the benefit unde application(s) listed below:	r 35 U.S.C. Section 119(e)	of any United States provisional
(Application Serial No.)	(Filing Date)	
(Application Serial No.)	(Filing Date)	
(Application Serial No.)	(Filing Date)	
	ach of the claims of this app application in the manner p the duty to disclose to the le to be material to patentabite between the filing date of	United States Patent and Trademark lity as defined in Title 37, C. F. R.,
	(Filing Date)	(Status) (patented, pending, abandoned)
(Application Serial No.) (Application Serial No.)	(Filing Date)	(Status) (patented, pending, abandoned)
(Application Serial No.)	(Filing Date)	(Status) (patented, pending, abandoned)

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.



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